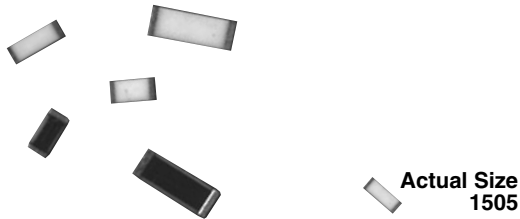


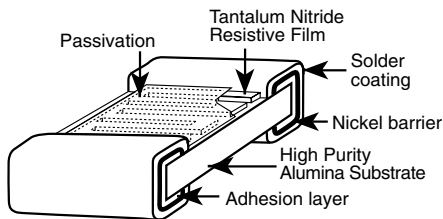
Commercial Thin Film Chip Resistors

SURFACE MOUNT CHIPS



These chip resistors are available in both “top side” and “wraparound” termination styles in a variety of sizes. They incorporate self passivated, enhanced Tantalum Nitride films, to give superior performance on moisture resistance, voltage coefficient, power handling and resistance stability. The terminations consist of an adhesion layer, a leach resistant nickel barrier, and solder coating. This product will out-perform all requirements of characteristic H of MIL-PRF-55342.

CONSTRUCTION



FEATURES

- Lead (Pb)-free available
- Moisture resistant
- High purity alumina substrate
- Non-standard values available
- Will pass + 85 °C, 85 % relative humidity and 10 % rated power
- 100 % visual inspected per MIL-PRF-55342
- Very low noise and voltage coefficient (< - 30 dB)
- Non-inductive
- Laser-trimmed tolerances to ± 0.1 %
- Wraparound resistance less than 10 milliohms



RoHS*
COMPLIANT

TYPICAL PERFORMANCE

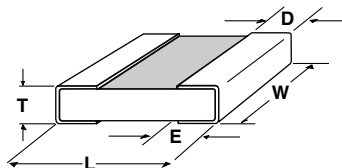
	ABS
TCR	25
TOL	0.1

STANDARD ELECTRICAL SPECIFICATIONS

TEST	SPECIFICATIONS	CONDITIONS
MATERIAL	TANTALUM NITRIDE	
Absolute TCR	± 25 ppm/°C, ± 50 ppm/°C, ± 100 ppm/°C	- 55 °C to + 125 °C
Absolute Tolerance	± 1.0 %, ± 0.5 % and ± 0.1 %	+ 25 °C
Operating Temperature Range	- 55 °C to + 125 °C	
Noise	< - 25 dB	

CASE SIZE	POWER RATING - (mW)	MAX. WORKING VOLTAGE	RESISTANCE RANGE - (Ω)
0402	50	75	20 - 35K
0502	100	75	20 - 65K
0505	150	75	20 - 130K
0603	150	75	10 - 80K
0705	200	100	10 - 300K
0805	200	100	10 - 300K
1005	250	100	10 - 300K
1010	500	150	50 - 600K
1206	400	200	10 - 1M
1505	400	150	10 - 1M
2208	750	150	10 - 1.75M
2010	800	200	10 - 2M
2512	1000	200	10 - 3M

* Pb containing terminations are not RoHS compliant, exemptions may apply

DIMENSIONS in inches


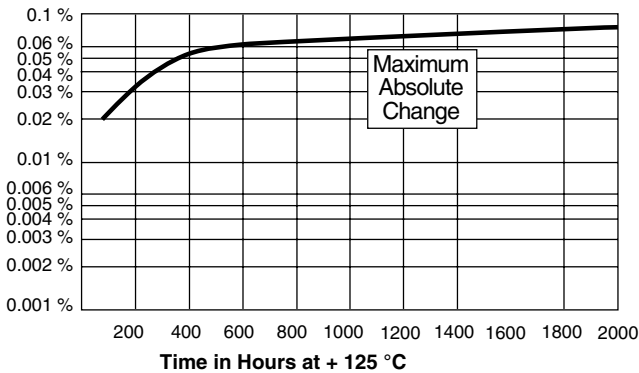
CASE SIZE	TERM	L	W	T	D	E
0402	B	0.042 ± 0.008	0.022 ± 0.005	0.012 to 0.033	0.010 ± 0.005	0.010 ± 0.005
0502	B	0.055 ± 0.006	0.025 ± 0.005	0.012 to 0.033	0.010 ± 0.005	0.015 ± 0.005
0505	B	0.055 ± 0.006	0.050 ± 0.005	0.012 to 0.033	0.010 ± 0.005	0.015 ± 0.005
0603	B	0.064 ± 0.006	0.032 ± 0.005	0.020 Max.	0.012 ± 0.005	0.015 ± 0.005
0705	B	0.080 ± 0.006	0.050 ± 0.005	0.015 to 0.033	0.015 ± 0.005	0.015 ± 0.005
0805	B	0.080 ± 0.006	0.050 ± 0.005	0.015 to 0.033	0.015 ± 0.005	0.015 ± 0.005
1005	B	0.105 ± 0.007	0.050 ± 0.005	0.015 to 0.033	0.015 ± 0.005	0.015 ± 0.005
1010	B	0.105 ± 0.007	0.100 ± 0.005	0.015 to 0.033	0.015 ± 0.005	0.015 ± 0.005
1206	B	0.126 ± 0.008	0.063 ± 0.005	0.015 to 0.033	0.020 + 0.005, - 0.010	0.020 + 0.005, - 0.010
1505	B	0.155 ± 0.007	0.050 ± 0.005	0.015 to 0.033	0.015 ± 0.005	0.015 ± 0.005
2010	B	0.209 ± 0.009	0.098 ± 0.005	0.015 to 0.033	0.020 ± 0.005	0.020 ± 0.005
2208	B	0.230 ± 0.007	0.075 ± 0.005	0.015 to 0.033	0.020 ± 0.005	0.020 ± 0.005
2512	B	0.259 ± 0.009	0.124 ± 0.005	0.015 to 0.033	0.020 ± 0.005	0.020 ± 0.005

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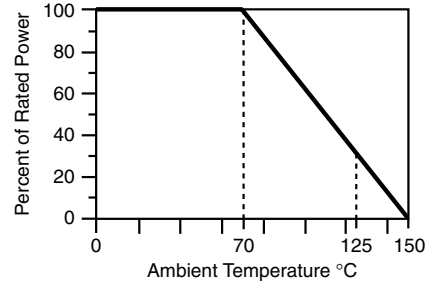
ENVIRONMENTAL TESTS (VISHAY PERFORMANCE VS. MIL-PRF-55342 REQUIREMENTS)		
ENVIRONMENTAL TEST	LIMITS MIL-PRF-55342 CHARACTERISTIC "H"	TYPICAL VISHAY PERFORMANCE
Resistance Temperature Characteristic	± 50 ppm/°C	± 35 ppm/°C
Max. Ambient Temp. at Rated Wattage	+ 70 °C	+ 70 °C
Max. Ambient Temp. at Power Derating	+ 150 °C	+ 150 °C
Thermal Shock ΔR	± 0.25 %	± 0.040 %
Low Temperature Operation ΔR	± 0.25 %	± 0.005 %
Short Time Overload ΔR	± 0.10 %	± 0.010 %
High Temperature Exposure ΔR	± 0.20 %	± 0.150 %
Resistance to Bonding Exposure ΔR	± 0.25 %	± 0.005 %
Moisture Resistance ΔR	± 0.40 %	± 0.029 %
Life + 70 °C at 1000 hours ΔR	± 0.50 %	± 0.035 %
Insulation Resistance Ω	10 000 Minimum	> 100 000 M Ω



FILM LOAD LIFE STABILITY (at + 125 °C)



DERATING CURVE



GLOBAL PART NUMBER INFORMATION

New Global Part Numbering: **PTN1206E1002BBT1** (preferred part number format)

P	T	N	1	2	0	6	E	1	0	0	2	B	B	T	1
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GLOBAL MODEL	CASE SIZE	TCR CHARACTERISTIC	RESISTANCE	TOLERANCE	TERMINATION	PACKAGING
PTN	0402 0502 0505 0603 0805 1005 1010 1206 1505 2208 2010 2512	E = ± 25 ppm/°C H = ± 50 ppm/°C K = ± 100 ppm/°C < 50 Ω ± 100 ppm/°C best	The first 3 digits are significant figures and the last digit specifies the number of zeros to follow. "R" designates the decimal point. Example: 10R0 = 10 Ω 1000 = 100 Ω 1001 = 1 kΩ	B = ± 0.1 % D = ± 0.5 % F = ± 1 % G = ± 2 % J = ± 5 % S = Special	B = Solderable G = Epoxy/Solderable S = Lead (Pb)-free (e1)	BS = BULK 100 Min 1 Mult WS = WAFFLE 100 Min 1 Mult TAPE AND REEL T0 = 100 Min 100 Mult T1 = 1000 Min 1000 Mult T3 = 300 Min 300 Mult T5 = 500 Min 500 Mult TF = Full Reel 2500 TS = 100 Min 1 Mult

Historical Part Number example: **PTN0705H8801BBT** (will continue to be accepted)

PTN	0705	H	8801	B	B	T
STYLE	CASE SIZE	TCR CHARACTERISTIC	OHMIC VALUE	TOLERANCE	TERMINATION	PACKAGING

SURFACE MOUNT CHIPS



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